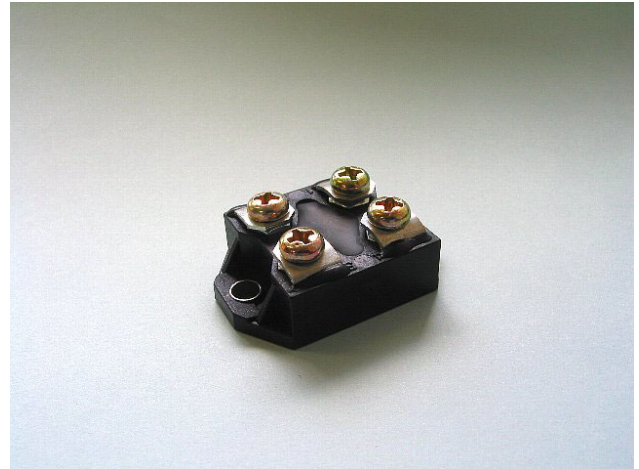


**CHASSIS MOUNTING NON-INDUCTIVE
HIGH POWER RESISTORS**

RPG250, RPG300



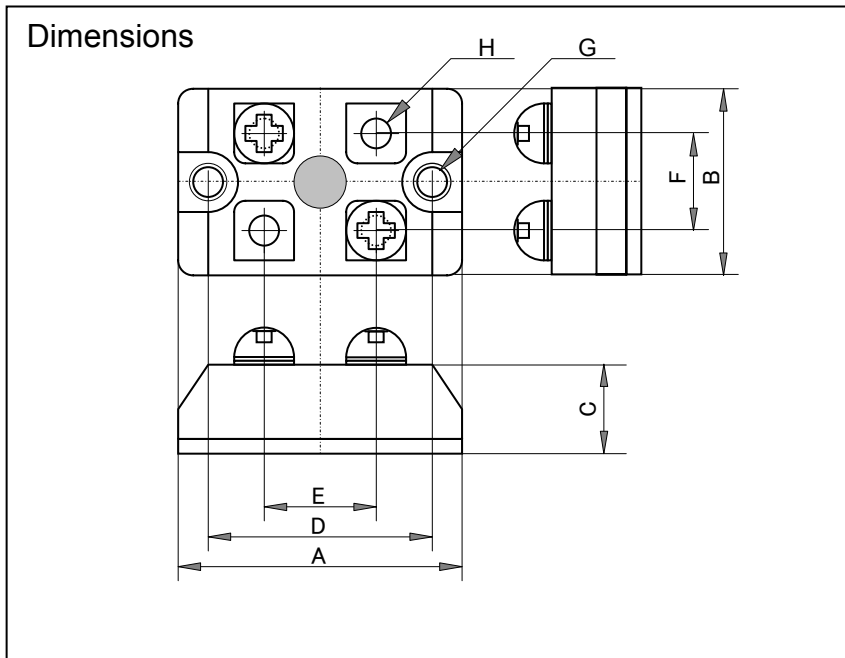
Features and Applications

Small size TO227, 200W high power resistor. Attaching an air-cooled heat sink or water-cooling is necessary. Rated power is 300W (one element) or 250W (two elements).

M4 screw terminals, very low series inductance.

Higher density packing, vibration-proof and perfect heat dissipation possible.

Applications include snubber resistors for power supplies, gate resistors, pulse generators, high frequency amplifiers, dumping resistance of theater audio equipment of dividing network of loud speaker systems, etc.



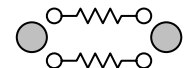
Dimensions

Symbols	(mm)	Note
A	38+/-0.5	
B	25+/-0.5	
C	15+/-0.5	
D	30+/-0.2	
E	15+/-0.5	
F	13+/-0.5	
G	2-3.2dia.	
H	4-M4.0	

Schematics



RPG300



RPG250

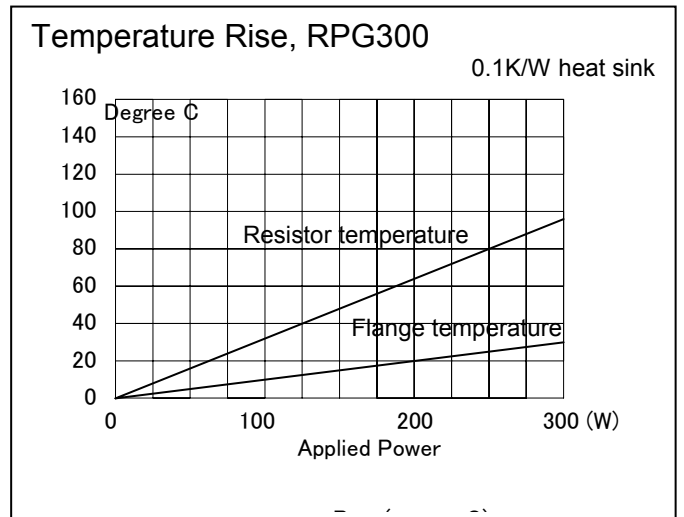
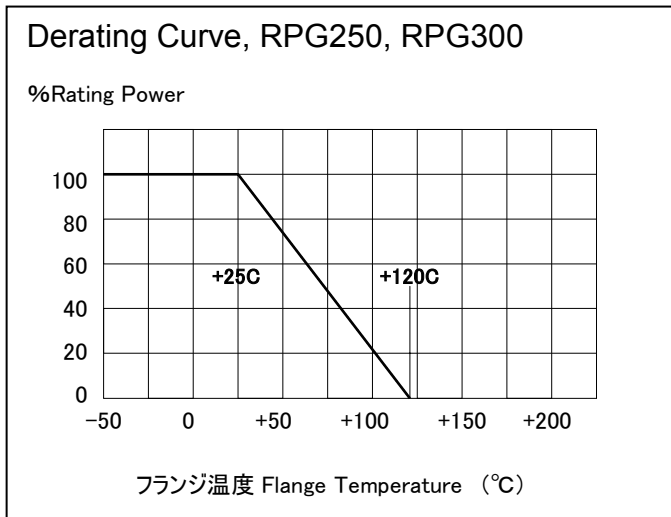
Ordering Information

P/N	Type	TCR	Resistance	Tolerance	Note
RPG250A10+10ohmJ	RPG250	A(100ppm/K)	10+10ohm	J(5%)	Two resistors
RPG250A50+50ohmJ	RPG250	A(100ppm/K)	50+50ohm	J(5%)	Two resistors
RPG300A50ohmJ	RPG300	A(100ppm/K)	50ohm	J(5%)	One resistor
RPG300A100ohmJ	RPG300	A(100ppm/K)	100ohm	J(5%)	One resistor

CHASSIS MOUNTING NON-INDUCTIVE HIGH POWER RESISTORS
RPG-250, RPG-300

Specifications and Performances

Specification Items	RPG250	RPG300	Test Conditions
Rating Power	250 Watts	300 Watts	At flange temperature -55 to +25 degree C
Resistance Range	1ohm to 1Kohm Dual	1ohm to 1Kohm Single	
Nominal Resistance	E24+	E24+	Additionally, 2.0 and 5.0.
TCR	+/-100 ppm/K(A)	+/-100 ppm/K(A)	For -55 to +120 C
Tolerance	+/-5%(J)	+/-5%(J)	
Operation Temp. Range	-55 - +120 C	-55 - +120 C	
Max. Applied Voltage	$E = \sqrt{P \cdot R}$		
Withstanding Voltage	2500 VAC		60 seconds.
Load Life	+/- (1.0 % + 0.05 ohm)		25C, 90 min.ON, 30min.OFF, 1000hours.
Humidity	+/- (1.0 % + 0.05 ohm)		70C, 90 to 95%RH, DC0.1W, 1000hours.
Temperature Cycle	+/- (1.0 % + 0.05 ohm)		-55C, 30 min., +155C 30min., 20cycles. (-55C, 30 min., +120C, 30min., 20cycles. at RPG300)
Short Time Overload	+/- (0.25 % + 0.05 ohm)		Rating watt x 2.5, 2.5seconds, with heat sink.
Soldering Heat	+/- (0.25 % + 0.05 ohm)		350 C +/- 5 C, 3seconds,
Solderability	Soldering is not available		-
Insulation Resistance	Over 1000 Mohm		Between terminals and flange.
Vibration	+/- (0.25 % + 0.05 ohm)		



Materials

Flange: Ni plated copper plate.
 Substrate: Al₂O₃ alumina substrate.
 Resistor: Metal film resistor.
 Case: Polycarbonate plastics.
 Terminals: Ni plated copper alloy
 Screw: 4-M4/10mm.